

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	113	(solder adj (bump, ball) with eutectic).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:08
L2	6678	(solder adj (bump, ball)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:08
L3	104269	(board, pcb).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:09
L4	1921	2 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:09
L5	198158	(resin, epoxy).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:09
L6	546	4 and 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:10
L7	38	1 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/31 17:10
L8	60	("4505029" "4967950" "4999699" "5007163" "5075965" "5130779" "5147084" "5188280" "5251806" "5431328" "5439162" "5470787" "5611481" "5698465").PN. OR ("5796591").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/31 17:21